

### Typical Applications

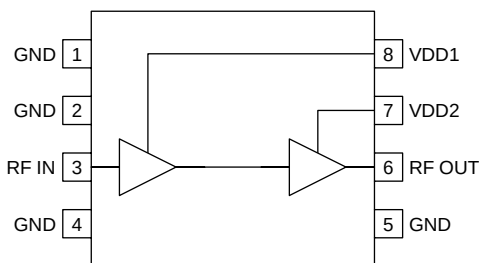
- Local Oscillator Buffer Amplifiers
- FDD and TDD Communication Systems
- Commercial and Consumer Systems
- Portable Battery-Powered Equipment
- Wireless LAN
- ISM Band Applications

### Product Description

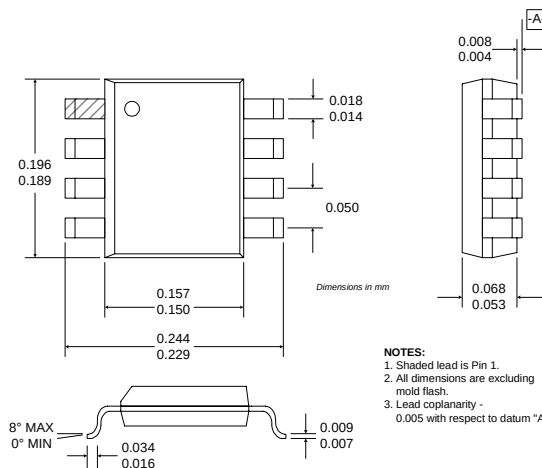
The RF2301 is a high reverse isolation buffer amplifier. The device is manufactured on a low-cost Gallium Arsenide MESFET process, and has been designed for use as a general purpose buffer in high-end communication systems operating at frequencies from less than 300MHz to higher than 2500MHz. With +5dBm output power, it may also be used as a driver in transmitter applications. The device is packaged in an 8-lead plastic package. The product is self-contained, requiring just a resistor and blocking capacitors to operate. The output power, combined with 50dB reverse isolation at 900MHz allows excellent buffering of LO sources to impedance changes. The device can be used in 3V battery applications. The unit has a total gain of 17dB with only 14mA current from a 3V supply.

#### Optimum Technology Matching® Applied

- |                                     |                                   |                                                 |
|-------------------------------------|-----------------------------------|-------------------------------------------------|
| <input type="checkbox"/> Si BJT     | <input type="checkbox"/> GaAs HBT | <input checked="" type="checkbox"/> GaAs MESFET |
| <input type="checkbox"/> Si Bi-CMOS | <input type="checkbox"/> SiGe HBT | <input type="checkbox"/> Si CMOS                |



Functional Block Diagram



Package Style: SOIC-8

### Features

- Single 2.7V to 6.0V Supply
- +4dBm Output Power
- 21dB Small Signal Gain
- 50dB Reverse Isolation at 900MHz
- Low DC Current Consumption of 14mA
- 300MHz to 2500MHz Operation

### Ordering Information

- |             |                                  |
|-------------|----------------------------------|
| RF2301      | High Isolation Buffer Amplifier  |
| RF2301 PCBA | Fully Assembled Evaluation Board |

RF Micro Devices, Inc.  
 7628 Thorndike Road  
 Greensboro, NC 27409, USA

Tel (336) 664 1233  
 Fax (336) 664 0454  
<http://www.rfmd.com>

# RF2301

## Absolute Maximum Ratings

| Parameter                     | Rating       | Unit        |
|-------------------------------|--------------|-------------|
| Supply Voltage ( $V_{DD}$ )   | -0.5 to +6.5 | $V_{DC}$    |
| DC Supply Current             | 60           | mA          |
| Input RF Power                | +10          | dBm         |
| Operating Ambient Temperature | -40 to +85   | $^{\circ}C$ |
| Storage Temperature           | -40 to +150  | $^{\circ}C$ |



**Caution!** ESD sensitive device.

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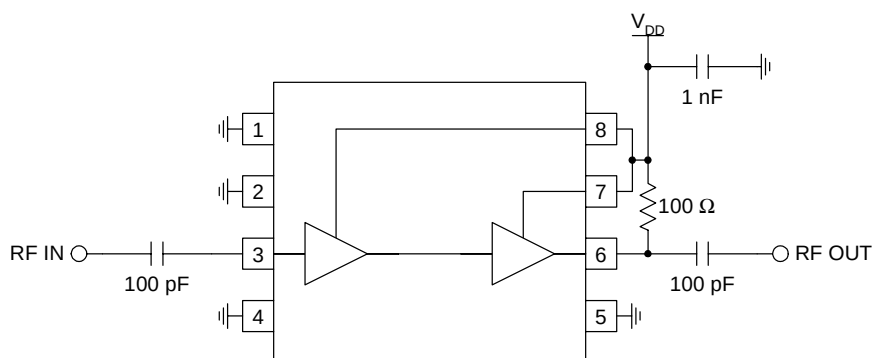
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GENERAL PURPOSE  
AMPLIFIERS

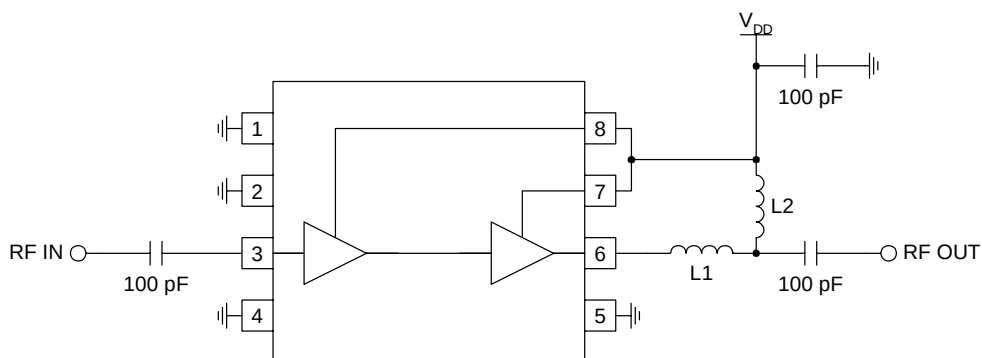
| Parameter                       | Specification |             |      | Unit | Condition                                                                                 |
|---------------------------------|---------------|-------------|------|------|-------------------------------------------------------------------------------------------|
|                                 | Min.          | Typ.        | Max. |      |                                                                                           |
| <b>Overall</b>                  |               |             |      |      | $T=25^{\circ}C$ , $V_{DD}=5V_{DC}$                                                        |
| Nominal Frequency Range         |               | 300 to 2500 |      | MHz  |                                                                                           |
| Input IP <sub>3</sub>           |               | -8          |      | dBm  |                                                                                           |
| Noise Figure                    |               |             | 8    | dB   |                                                                                           |
| Input VSWR                      |               | <2:1        |      |      | In a 50 $\Omega$ system                                                                   |
| Output VSWR                     |               | <2:1        |      |      | In a 50 $\Omega$ system                                                                   |
| Power Supply Voltage            |               | 2.7 to 6.0  |      | V    |                                                                                           |
| <b>Nominal 5V Configuration</b> |               |             |      |      | Using Broad Band Application Circuit,<br>$V_{DD}=5V_{DC}$ , Freq=2500MHz, $T=25^{\circ}C$ |
| Gain                            | 21            | 24          | 26   | dB   |                                                                                           |
| P <sub>1dB</sub> Output Power   |               | +4          |      | dBm  |                                                                                           |
| Supply Current                  | 10            | 30          | 40   | mA   |                                                                                           |
| Reverse Isolation               |               | 50          |      | dB   | 900MHz, without RF input                                                                  |
|                                 |               | 50          |      | dB   | 900MHz, with RF input, saturated                                                          |
|                                 |               | 40          |      | dB   | 2500MHz, without RF input                                                                 |
|                                 |               | 40          |      | dB   | 2500MHz, with RF input, saturated                                                         |
| <b>Nominal 3V Configuration</b> |               |             |      |      | Using Broad Band Application Circuit,<br>$V_{DD}=3V_{DC}$ , Freq=2500MHz, $T=25^{\circ}C$ |
| Gain                            | 15            | 17          |      | dB   |                                                                                           |
| P <sub>1dB</sub> Output Power   |               | 0           |      | dBm  |                                                                                           |
| Supply Current                  |               | 14          |      | mA   |                                                                                           |
| Reverse Isolation               |               | 50          |      | dB   | 900MHz, without RF input                                                                  |
|                                 |               | 50          |      | dB   | 900MHz, with RF input, saturated                                                          |
|                                 |               | 40          |      | dB   | 2500MHz, without RF input                                                                 |
|                                 |               | 40          |      | dB   | 2500MHz, with RF input, saturated                                                         |

| Pin | Function | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                            | Interface Schematic |
|-----|----------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------|
| 1   | GND      | Low inductance ground connections. Use individual vias to backside ground plane, placed within 0.030" of pin landing for optimum performance.                                                                                                                                                                                                                                                                                                                          |                     |
| 2   | GND      | Same as pin 1.                                                                                                                                                                                                                                                                                                                                                                                                                                                         |                     |
| 3   | RF IN    | DC-coupled RF input. A broadband impedance match is produced by internal shunt resistive feedback. The DC level is 0V. If a DC voltage is present from connected circuitry, an external DC-blocking capacitor is required for the proper DC operating point.                                                                                                                                                                                                           |                     |
| 4   | GND      | Same as pin 1.                                                                                                                                                                                                                                                                                                                                                                                                                                                         |                     |
| 5   | GND      | Same as pin 1.                                                                                                                                                                                                                                                                                                                                                                                                                                                         |                     |
| 6   | RF OUT   | Open drain RF output. A broadband impedance match is produced by an external 100Ω resistor to power supply as shown in Application Schematic 1. Approximately 3dB improvement in gain and output power can be obtained over at least a 20% bandwidth by replacing the resistor to power supply with an external chip inductor network as shown in Application Schematic 2. An external DC-blocking capacitor is required if the following circuitry is not DC-blocked. |                     |
| 7   | VDD2     | Power supply connections. Bypass with external chip capacitor and individual via to backside ground plane.                                                                                                                                                                                                                                                                                                                                                             |                     |
| 8   | VDD1     | Power supply connections. Bypass with external chip capacitor and individual via to backside ground plane.                                                                                                                                                                                                                                                                                                                                                             |                     |

## Application Schematic 1 Broadband Match



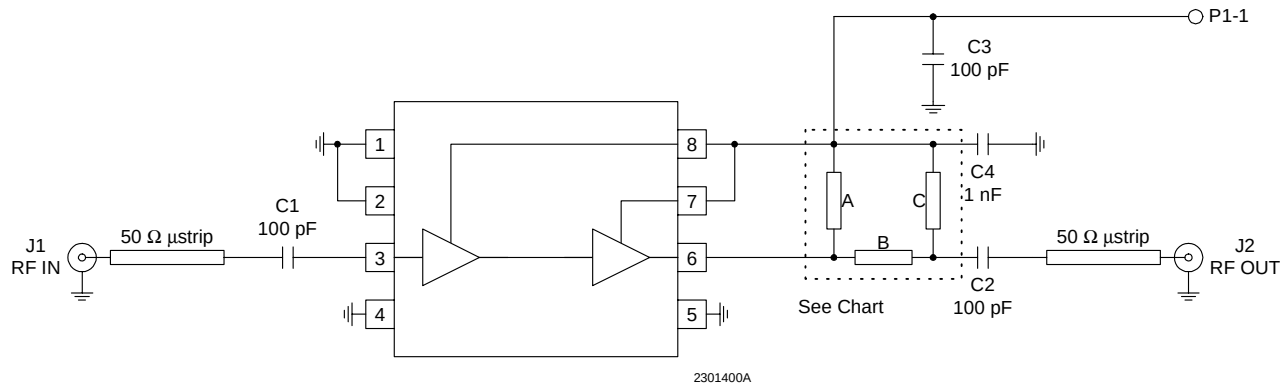
## Application Schematic 2 Optimum Match



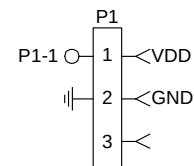
| FREQUENCY | L1    | L2     |
|-----------|-------|--------|
| 900 MHz   | 18 nH | 22 nH  |
| 2500 MHz  | ----  | 2.7 nH |

## Evaluation Board Schematic

(Download [Bill of Materials](http://www.rfmd.com) from [www.rfmd.com](http://www.rfmd.com).)



| FREQUENCY BAND              | COMPONENT |       |       |
|-----------------------------|-----------|-------|-------|
|                             | A         | B     | C     |
| BROADBAND (default config.) | 100 Ω     | 0 Ω   | N/A   |
| 900 MHz                     | N/A       | 18 nH | 22 nH |
| 2450 MHz                    | 2.7 nH    | 0 Ω   | N/A   |

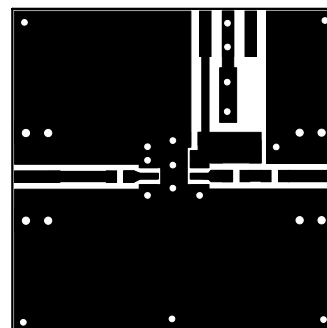
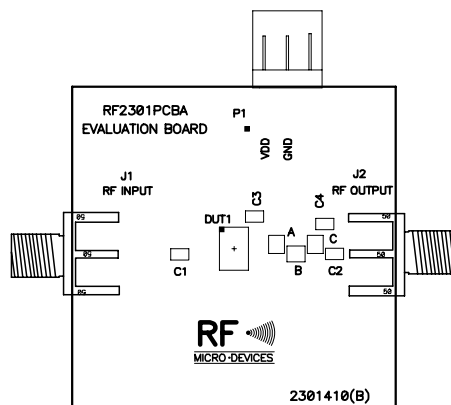


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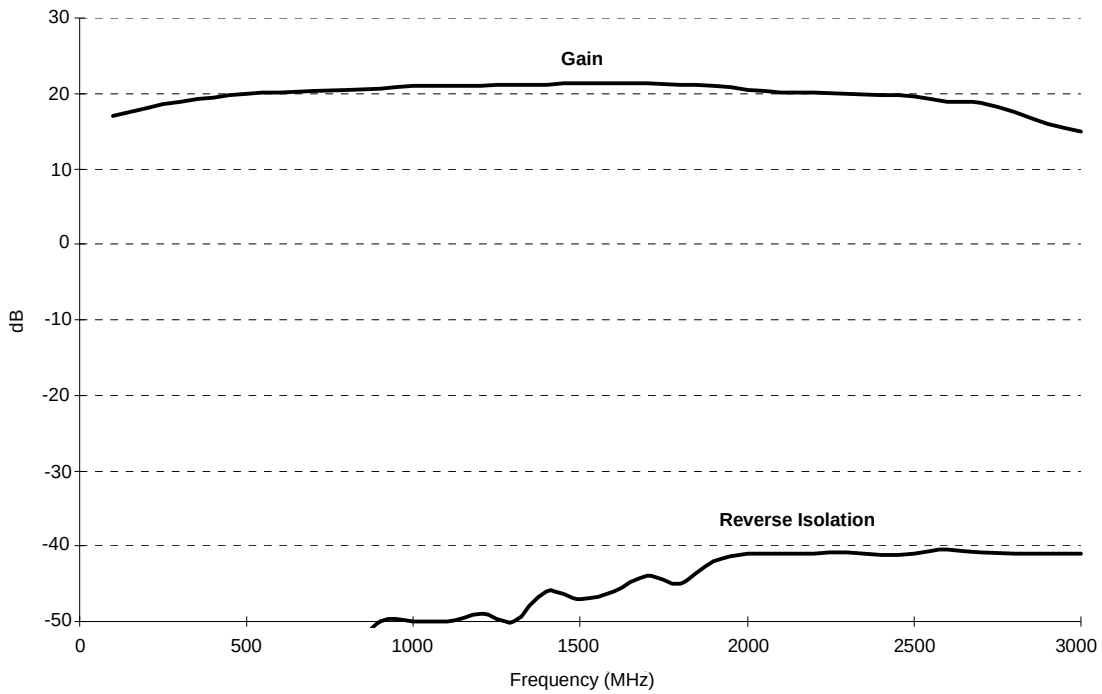
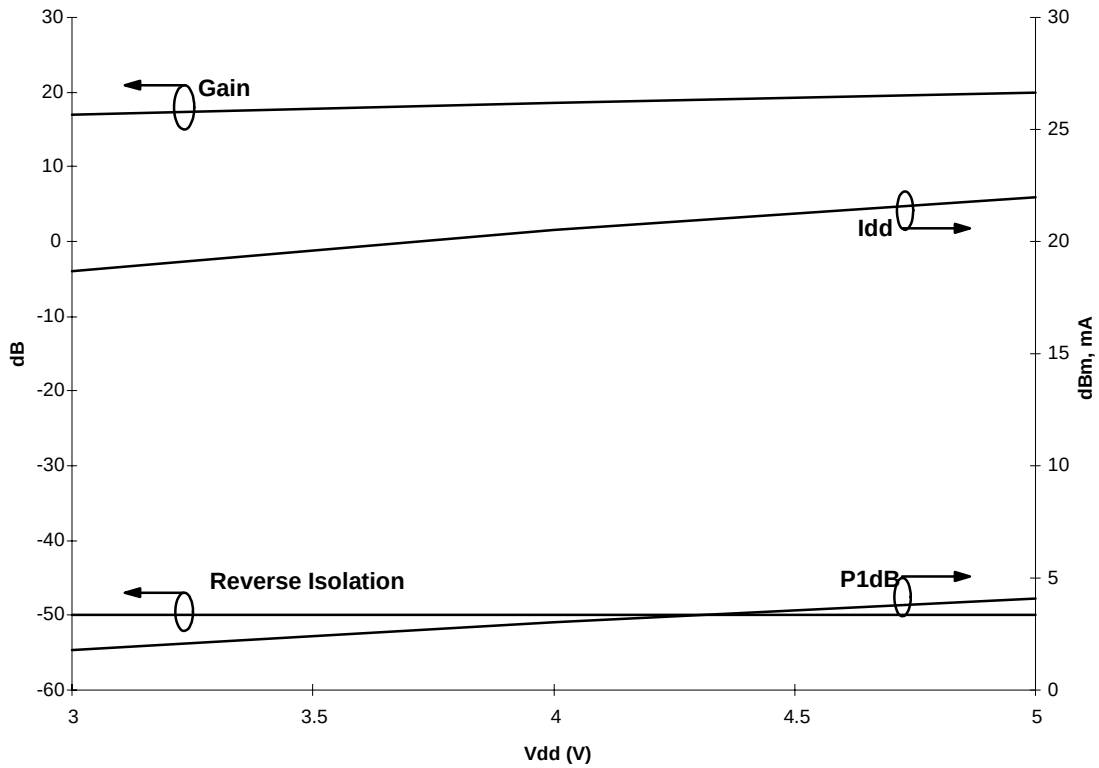
GENERAL PURPOSE AMPLIFIERS

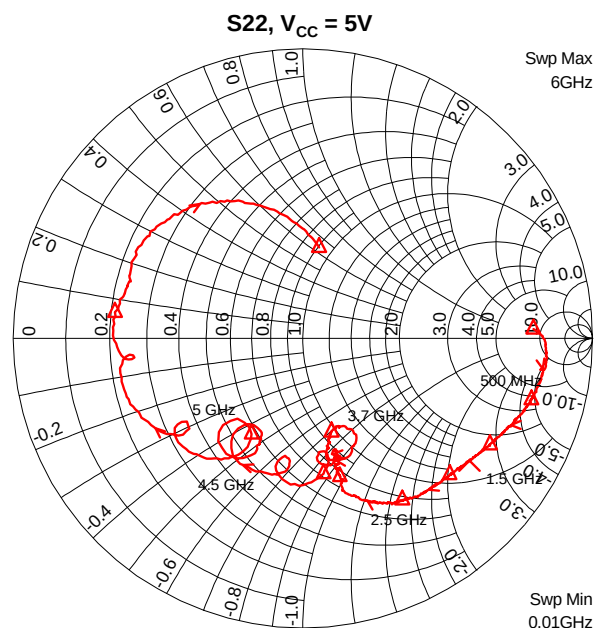
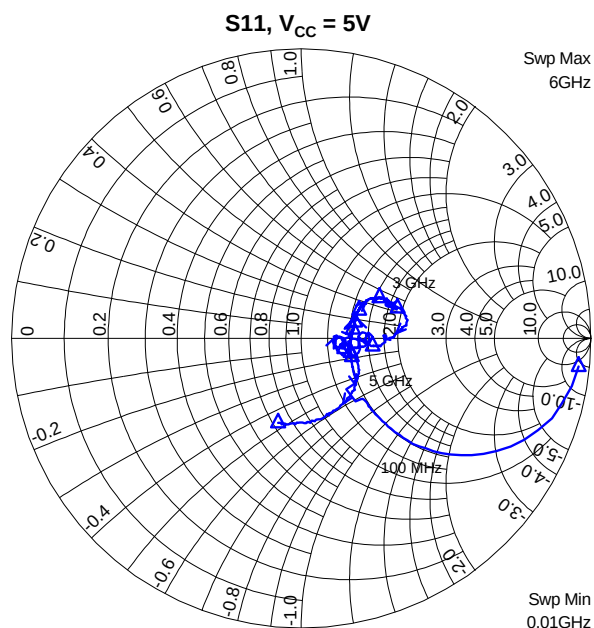
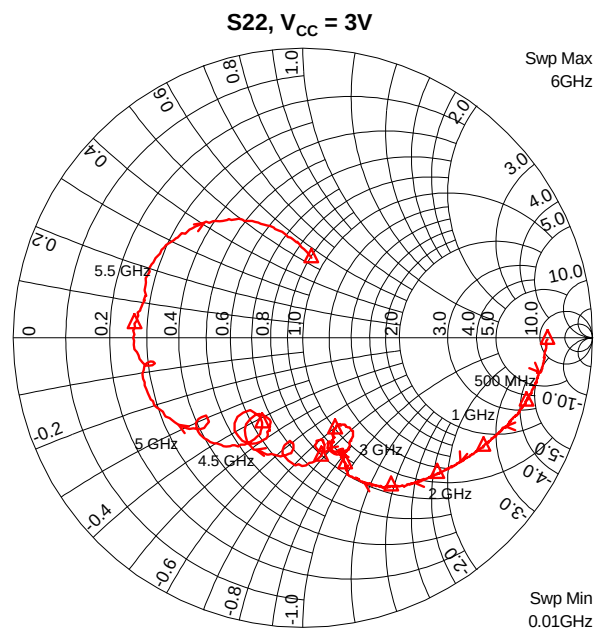
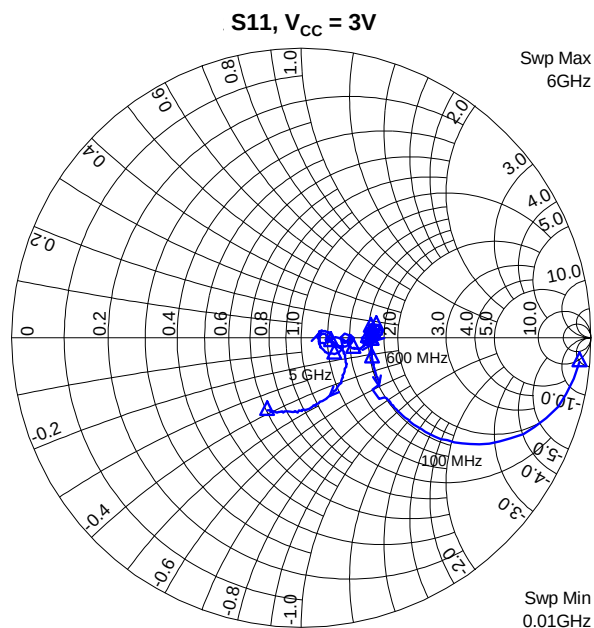
## Evaluation Board Layout

1.43" x 1.43"  
Board Thickness 0.031"; Board Material FR-4



## Typical Characteristics Broadband Application Circuit





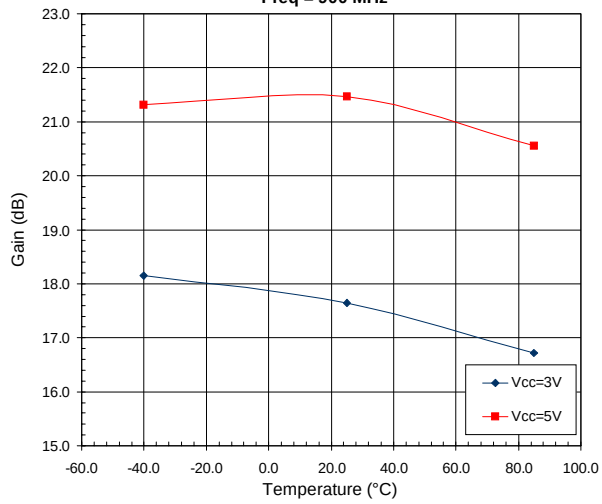
S-Parameter Conditions:

All plots are taken at ambient temperature=25°C.

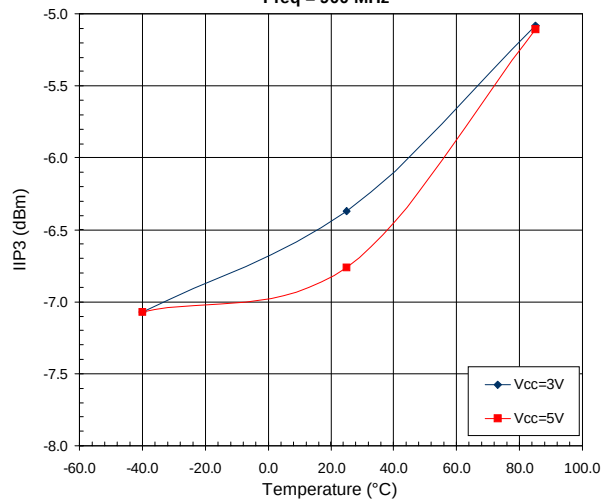
NOTE:

All S11 and S22 plots shown were taken from an RF2301 evaluation board with external input and output tuning components removed and the reference points at the RF IN and RF OUT pins.

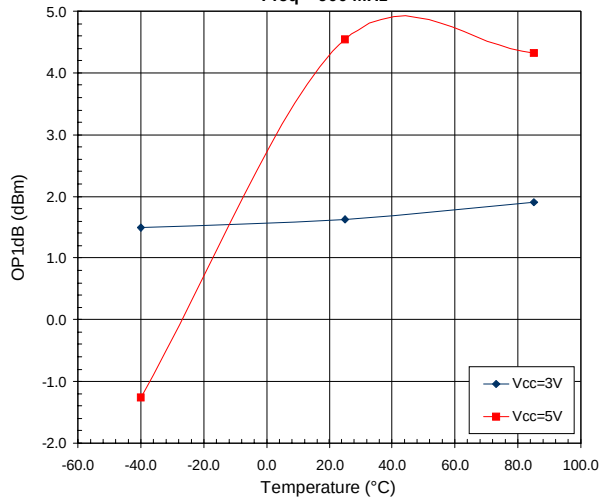
**Gain versus Temperature**  
Freq = 900 MHz



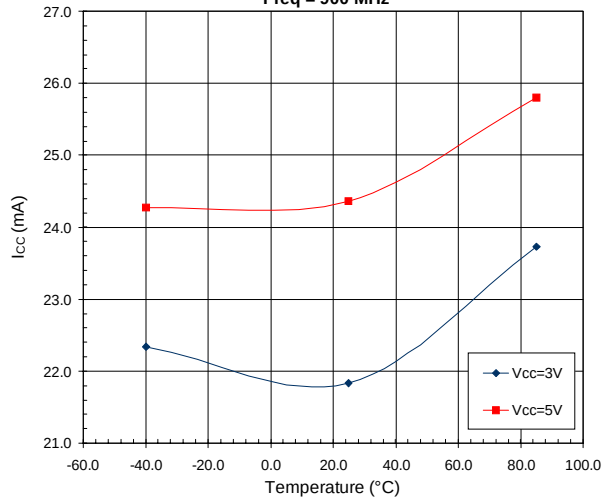
**IIP3 versus Temperature**  
Freq = 900 MHz



**OP1dB versus Temperature**  
Freq = 900 MHz

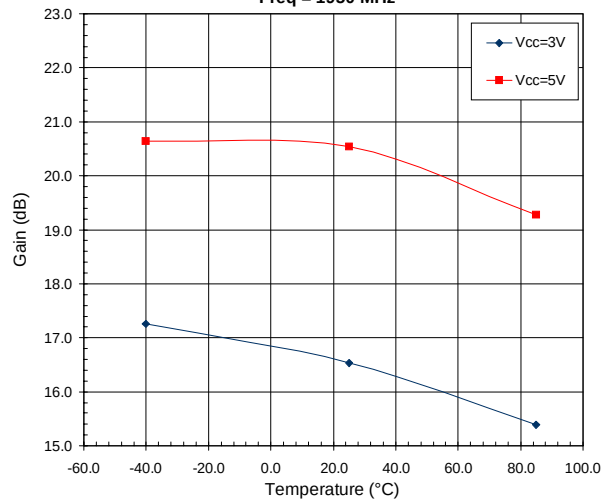


**Icc versus Temperature**  
Freq = 900 MHz

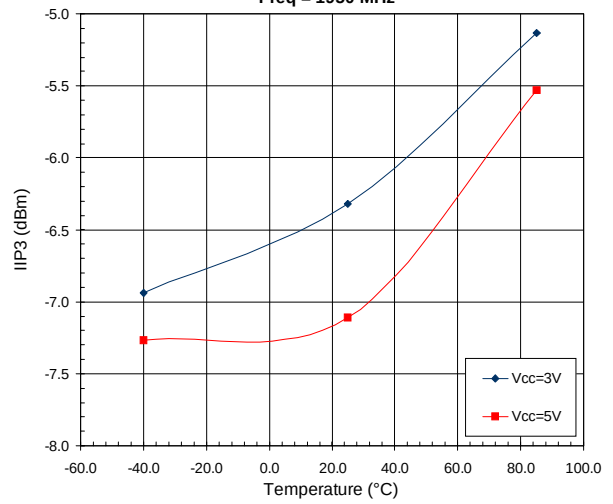




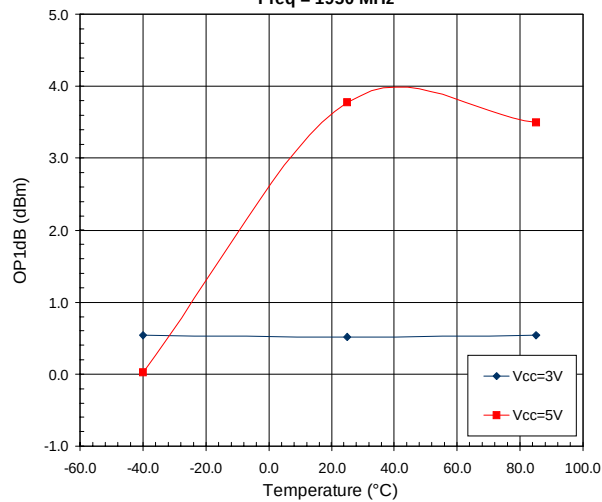
**Gain versus Temperature**  
Freq = 1950 MHz



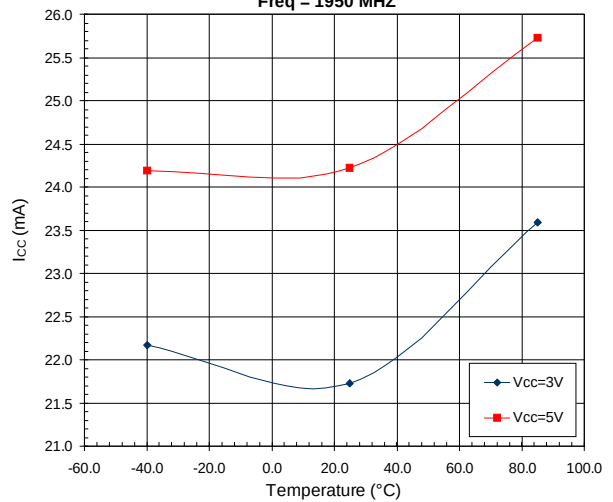
**IIP3 versus Temperature**  
Freq = 1950 MHz



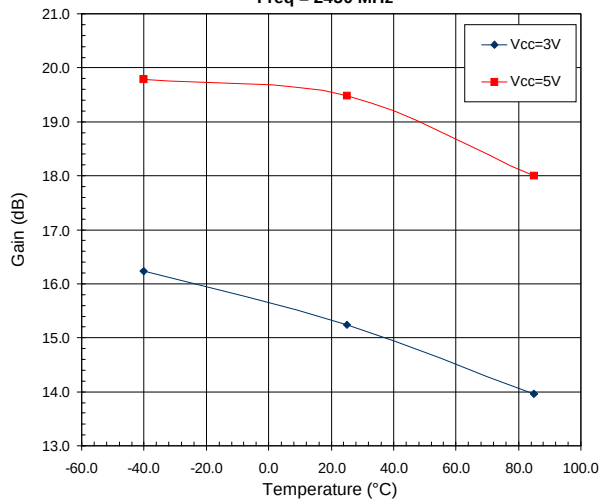
**OP1dB versus Temperature**  
Freq = 1950 MHz



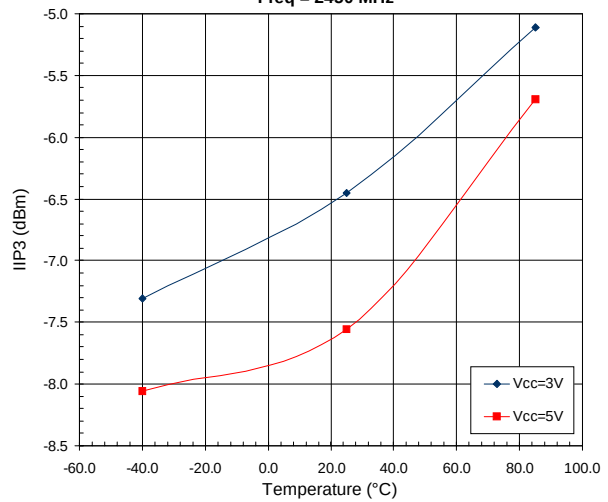
**I<sub>CC</sub> versus Temperature**  
Freq = 1950 MHz



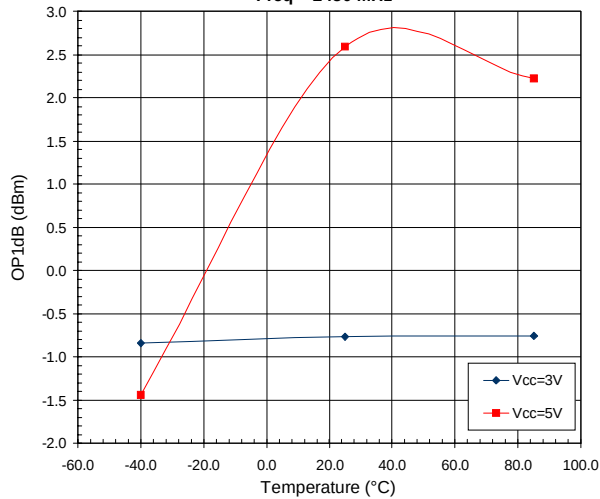
**Gain versus Temperature**  
Freq = 2450 MHz



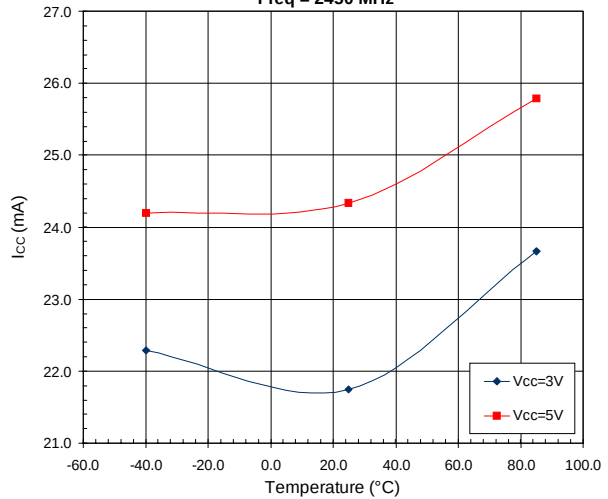
**IIP3 versus Temperature**  
Freq = 2450 MHz



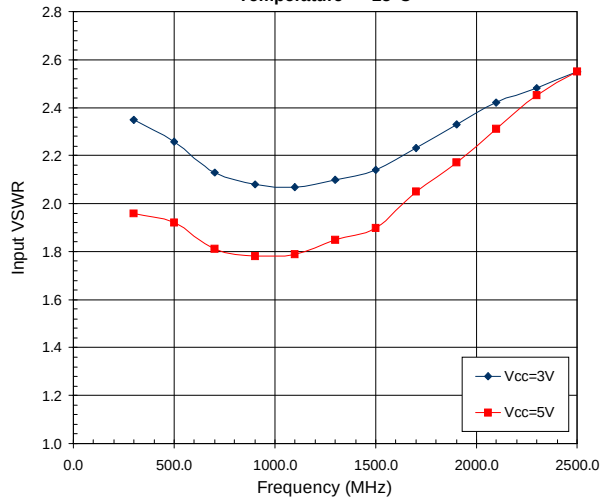
**OP1dB versus Temperature**  
Freq = 2450 MHz



**Icc versus Temperature**  
Freq = 2450 MHz



**S11 of Evaluation Board versus Frequency**  
Temperature = +25°C



**S22 of Evaluation Board versus Frequency**  
Temperature = +25°C

